



60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

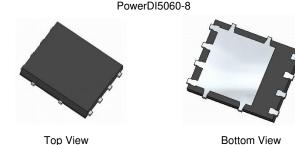
| BV _{DSS} | R _{DS(ON)} Max | I _D T _C = +25°C (Note 5) |
|-------------------|--------------------------------------|--|
| 60V | $5.5m\Omega$ @ V _{GS} = 10V | 100A |

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- High-frequency switching
- Sync rectification
- DC-DC converters

Site 1:



Site 2:

PowerDI5060-8/SWP (Type UX)







Bottom View

Bottom View

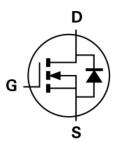
Features

- Rated to +175°C Ideal for High Ambient Temperature **Environments**
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low RDS(ON) Minimizes Power Losses
- Low Qg Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH6005LPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

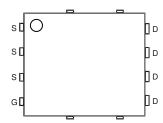
- Package: PowerDI®5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)



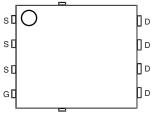
Internal Schematic



Internal Schematic



Top View Pin Configuration



Top View Pin Configuration

Ordering Information (Note 4)

| Part Number | Package | Packing | | |
|-----------------|-----------------------------|---------|-------------|--|
| Fait Number | rackaye | Qty. | Carrier | |
| DMTH6005LPSQ-13 | PowerDI5060-8 | 2500 | Tape & Reel | |
| DMTH6005LPSQ-13 | PowerDI5060-8/SWP (Type UX) | 2500 | Tape & Reel | |

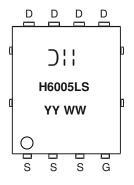
Notes:

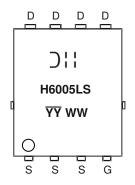
- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

DMTH6005LPSQ



Marking Information





☐ Manufacturer's Marking
☐ H6005LS = Product Type Marking Code
☐ YYWW = Date Code Marking
☐ YY or YY = Year (ex: 23 = 2023)
☐ WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|--|---|------------------|--------------|----|
| Drain-Source Voltage | | V _{DSS} | 60 | V |
| Gate-Source Voltage | | V _{GSS} | ±20 | V |
| Continuous Drain Current (Note 6) | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | lo | 20.6 17.2 | Α |
| Continuous Drain Current (Note 7) | $T_{C} = +25^{\circ}C$ (Note 5) $T_{C} = +100^{\circ}C$ | lσ | 100 90 | А |
| Maximum Continuous Body Diode Forward Current (Note 7) | Is | 100 | A | |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | I _{DM} | 160 | Α |
| Avalanche Current, L = 1mH | | las | 14.8 | Α |
| Avalanche Energy, L = 1mH | | Eas | 98 | mJ |

Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|--|----------------------|----------------|-------------|------|
| Total Power Dissipation (Note 6) | $T_A = +25^{\circ}C$ | P _D | 3.2 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | | Reja | 47 | °C/W |
| Total Power Dissipation (Note 7) | Tc = +25°C | PD | 150 | W |
| Thermal Resistance, Junction to Case (Note 7) | | Rejc | 1 | °C/W |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +175 | °C |

Notes:

- 5. Package limited.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).

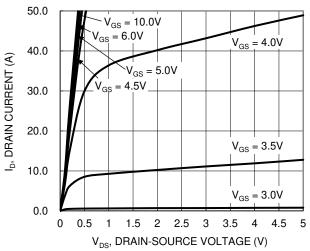


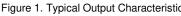
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

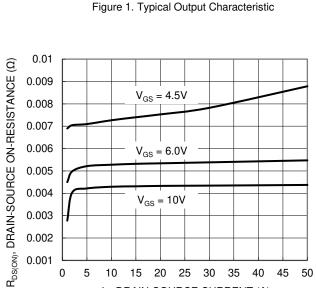
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-----|-------|------|------|---|--|
| OFF CHARACTERISTICS (Note 8) | | | | | | | |
| Drain-Source Breakdown Voltage | BVDSS | 60 | _ | _ | V | $V_{GS} = 0V$, $I_D = 1mA$ | |
| Zero Gate Voltage Drain Current | IDSS | _ | _ | 1 | μΑ | $V_{DS} = 48V$, $V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 8) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | 1 | _ | 3 | V | $V_{DS} = V_{GS}$, $I_D = 250\mu A$ | |
| | | | 4.4 | 5.5 | | $V_{GS} = 10V, I_{D} = 50A$ | |
| Static Drain-Source On-Resistance | RDS(ON) | _ | 5.7 | 7.2 | mΩ | $V_{GS} = 6V$, $I_D = 20A$ | |
| | | _ | 7.7 | 10 | | V _{GS} = 4.5V, I _D = 12.5A | |
| Diode Forward Voltage | VsD | _ | 0.9 | _ | V | V _G S = 0V, I _S = 50A | |
| DYNAMIC CHARACTERISTICS (Note 9) | | | | | | | |
| Input Capacitance | Ciss | _ | 2962 | _ | | ., | |
| Output Capacitance | Coss | _ | 965.2 | _ | pF | $V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$ | |
| Reverse Transfer Capacitance | C _{rss} | _ | 59.8 | _ | | | |
| Gate Resistance | Rg | _ | 0.66 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | |
| Total Gate Charge (V _{GS} = 10V) | Qg | _ | 47.1 | _ | | | |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | _ | 23.1 | _ | ~_ | V _{DD} = 30V, I _D = 50A | |
| Gate-Source Charge | Qgs | _ | 10.2 | _ | nC | | |
| Gate-Drain Charge | Q _{gd} | _ | 12.5 | _ | | | |
| Turn-On Delay Time | tD(ON) | _ | 8.3 | _ | | | |
| Turn-On Rise Time | tR | _ | 9.4 | _ | | $V_{DD} = 30V$, $V_{GS} = 10V$, $I_{D} = 30A$, $R_{G} = 3.3\Omega$ | |
| Turn-Off Delay Time | tD(OFF) | _ | 22 | _ | ns | | |
| Turn-Off Fall Time | tF | _ | 8.9 | _ | | | |
| Body Diode Reverse-Recovery Time | trr | _ | 40.4 | _ | ns | 1 004 45/44 4004/44 | |
| Body Diode Reverse-Recovery Charge | Qrr | _ | 49.7 | _ | nC | - IF = 30A, di/dt = 100A/μs | |

8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing. Notes:









I_D, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

25 30 35

20

45

50

40

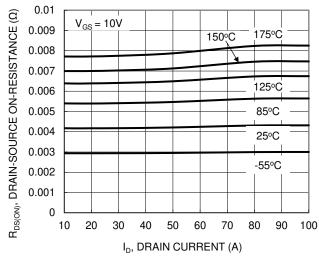


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

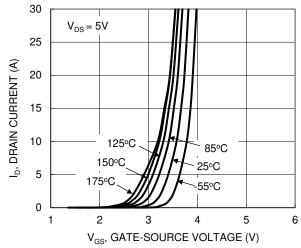


Figure 2. Typical Transfer Characteristic

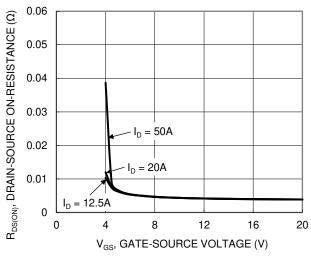


Figure 4. Typical Transfer Characteristic

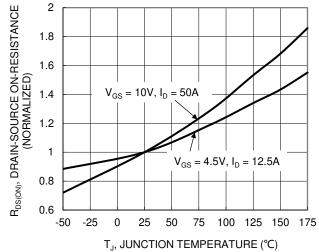


Figure 6. On-Resistance Variation with Junction Temperature

0.001

5

0

15



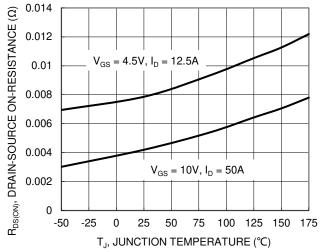


Figure 7. On-Resistance Variation with Junction Temperature

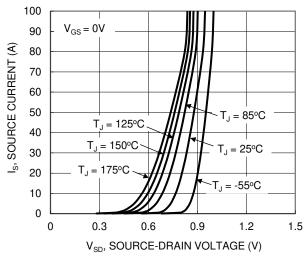


Figure 9. Diode Forward Voltage vs. Current

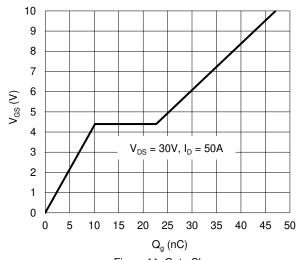


Figure 11. Gate Charge

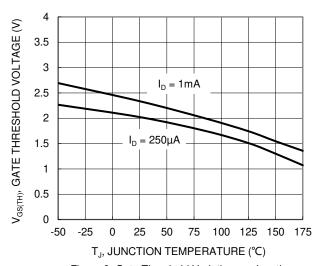


Figure 8. Gate Threshold Variation vs. Junction Temperature

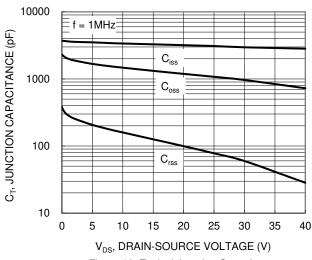


Figure 10. Typical Junction Capacitance

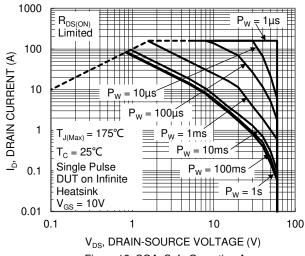


Figure 12. SOA, Safe Operation Area



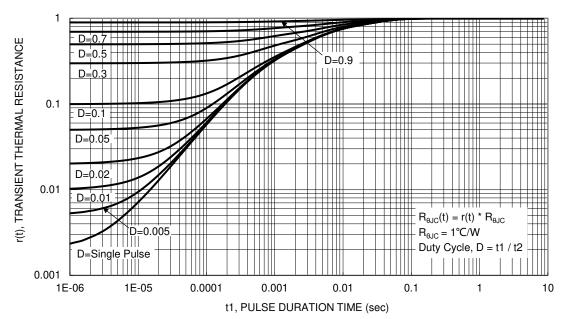


Figure 13. Transient Thermal Resistance

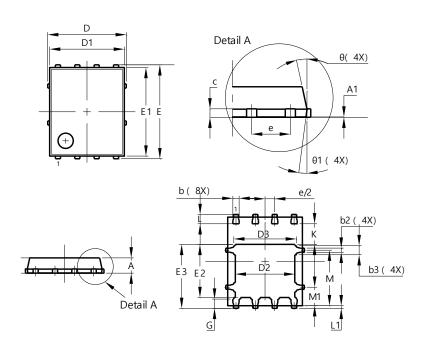


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

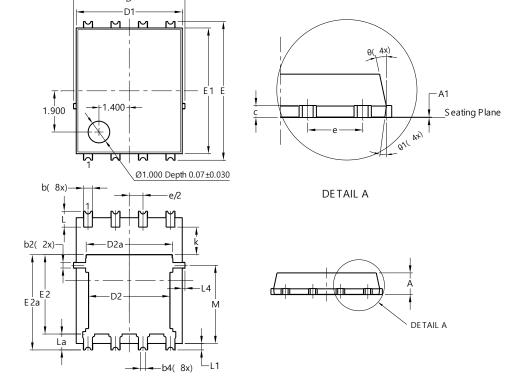
PowerDI5060-8



| PowerDI5060-8 | | | | |
|----------------------|-------|----------|-------|--|
| Dim | Min | Max | Тур | |
| Α | 0.90 | 1.10 | 1.00 | |
| A1 | 0.00 | 0.05 | _ | |
| b | 0.33 | 0.51 | 0.41 | |
| b2 | 0.200 | 0.350 | 0.273 | |
| b3 | 0.40 | 0.80 | 0.60 | |
| С | 0.230 | 0.330 | 0.277 | |
| D | | 5.15 BSC | ; | |
| D1 | 4.70 | 5.10 | 4.90 | |
| D2 | 3.70 | 4.10 | 3.90 | |
| D3 | 3.90 | 4.30 | 4.10 | |
| Е | (| 6.15 BSC | } | |
| E1 | 5.60 | 6.00 | 5.80 | |
| E2 | 3.28 | 3.68 | 3.48 | |
| E3 | 3.99 | 4.39 | 4.19 | |
| е | | 1.27 BSC | | |
| G | 0.51 | 0.71 | 0.61 | |
| K | 0.51 | - | - | |
| L | 0.51 | 0.71 | 0.61 | |
| L1 | 0.100 | 0.200 | 0.175 | |
| М | 3.235 | 4.035 | 3.635 | |
| M1 | 1.00 | 1.40 | 1.21 | |
| Θ | 10° | 12° | 11° | |
| Θ1 | 6° | 8° | 7° | |
| All Dimensions in mm | | | | |

Site 2:

PowerDI5060-8/SWP (Type UX)



| PowerDI5060-8/SWP | | | | |
|----------------------|----------|---------|--------|--|
| (Type UX) | | | | |
| Dim | Min | Max | Тур | |
| Α | 0.90 | 1.10 | 1.00 | |
| A 1 | 0 | 0.05 | | |
| b | 0.30 | 0.50 | 0.41 | |
| b2 | 0.20 | 0.35 | 0.25 | |
| b4 | C |).25REF | = | |
| С | 0.230 | 0.330 | 0.277 | |
| D | | .15 BS(| 3 | |
| D1 | 4.70 | 5.10 | 4.90 | |
| D2 | 3.56 | 3.96 | 3.76 | |
| D2a | 3.78 | 4.18 | 3.98 | |
| Е | 6 | .40 BS0 | \sim | |
| E1 | 5.60 | 6.00 | 5.80 | |
| E2 | 3.46 | 3.86 | 3.66 | |
| E2a | 4.195 | 4.595 | 4.395 | |
| е | 1.27BSC | | | |
| k | 1.05 | | | |
| L | 0.635 | 0.835 | 0.735 | |
| La | 0.635 | 0.835 | 0.735 | |
| L1 | 0.200 | 0.400 | 0.300 | |
| L1a | 0.050REF | | | |
| L4 | 0.025 | 0.225 | 0.125 | |
| М | 3.205 | 4.005 | 3.605 | |
| θ | 10° | 12° | 11° | |
| θ1 | 6° | 8° | 7° | |
| All Dimensions in mm | | | | |

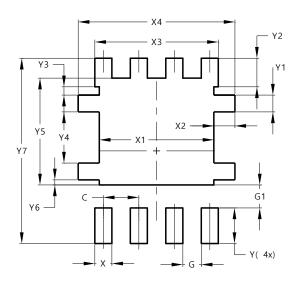


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

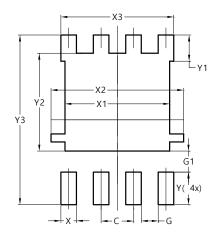
PowerDI5060-8



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 1.270 |
| G | 0.660 |
| G1 | 0.820 |
| Х | 0.610 |
| X1 | 4.100 |
| X2 | 0.755 |
| Х3 | 4.420 |
| X4 | 5.610 |
| Υ | 1.270 |
| Y1 | 0.600 |
| Y2 | 1.020 |
| Y3 | 0.295 |
| Y4 | 1.825 |
| Y5 | 3.810 |
| Y6 | 0.180 |
| Y 7 | 6.610 |

Site 2:

PowerDI5060-8/SWP (Type UX)



| Dimensions | Value | | |
|---------------|---------|--|--|
| פווטופווסוווט | (in mm) | | |
| С | 1.270 | | |
| G | 0.660 | | |
| G1 | 0.820 | | |
| X | 0.610 | | |
| X1 | 4.100 | | |
| X2 | 5.190 | | |
| Х3 | 4.420 | | |
| Υ | 1.270 | | |
| Y1 | 1.020 | | |
| Y2 | 3.810 | | |
| Y3 | 6.610 | | |



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